Status of Fiber ToF Tracker



UNIVERSITÉ DE GENÈVE

Eidgenössische Technische Hochschule Zürich

PAUL SCHERRER INSTITUT

50th BVR Review 28 January '19



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Swiss Federal Institute of Technology Zurich

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Quick Reminder

Design Parameters

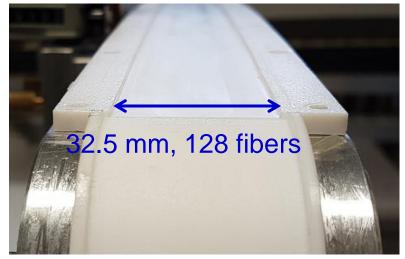
12 SciFi ribbons at ~6 cm radius 32.5 mm \times 300 mm 3 staggered layers of 250 μ m \oslash fibers SCSF-78MJ very thin ~0.2% x₀

Si-PM readout at both ends 128 ch SiPM array (LHCb design) 250 µm pitch

Readout MuTRiG ASIC 3000 readout channels

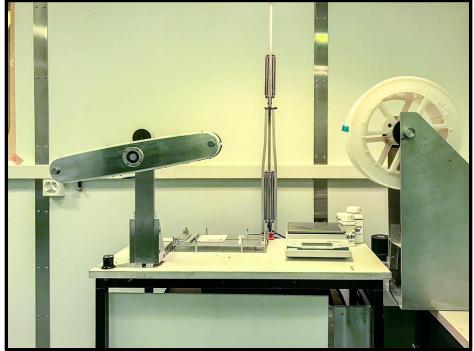
SciFi Ribbon Production

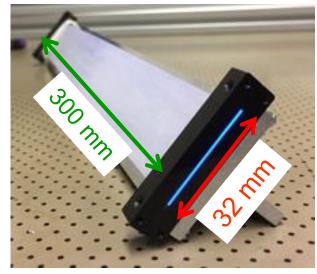
U channel



(full size) ribbon prototype

ribbon winding tool

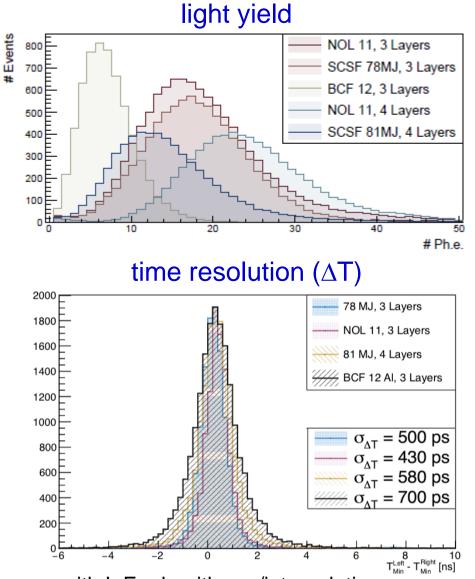




ribbon profile: 3 × ~125 fibers (prototype)

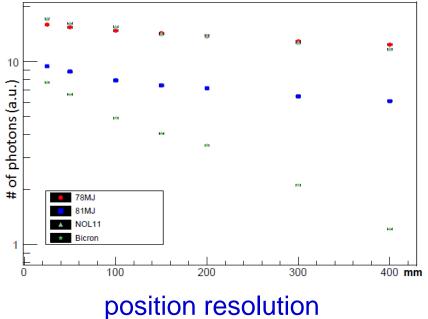
Ready to start production

SciFi Performance 1



with L.E. algorithm w/interpolation

light attenuation (Sr source)



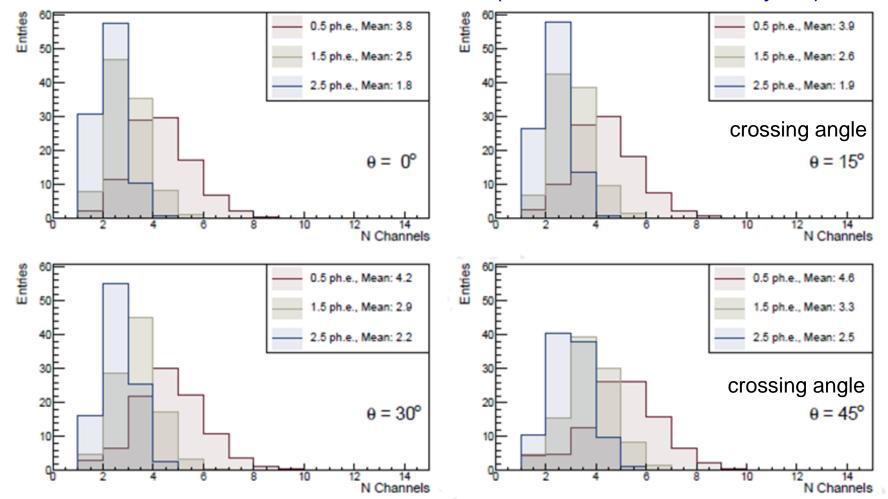
8500 Entri hAArrPos Entries 10125 χ² / ndf Ampl. 0 157.2 / 128 1935 2000 Mean 0 -0.389Sigma (0.5576 Ampl. 242.9 -0.4224 Mean 1 Sigma 1 1.292 1500 1000 500

4 Deviation from track / 250 µ m

2

SciFi Performance 2

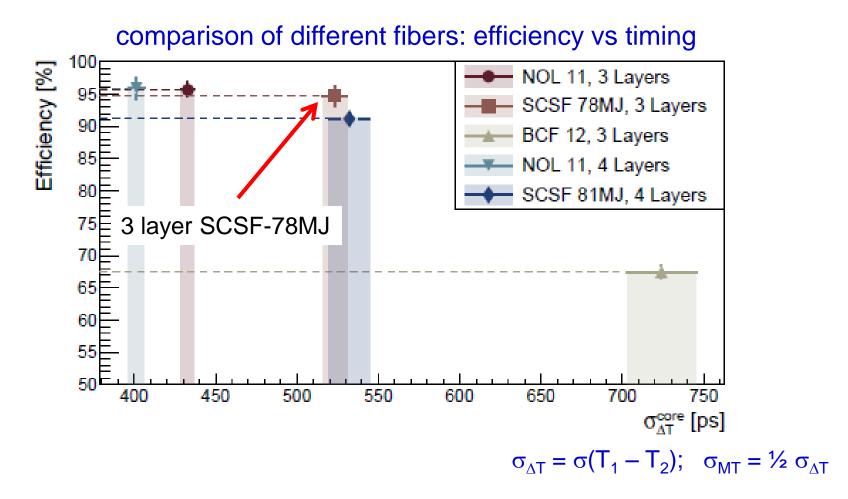
"cluster size" for different thresholds (SCSF-78MJ fiber, 3 layers)



important for reducing the data rate:

lower the threshold, larger the cluster \rightarrow higher the occupancy and the data rate (lower the light yield of fibers \rightarrow smaller the cluster size)

SciFi Performance 3

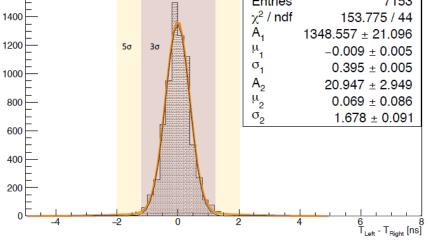


we require a cluster on each SciFi ribbon end (coincidence) cluster: at least two adjacent channels > 0.5 ph. el. threshold coincidence: \pm 3 σ timing cut timing with L.E. algorithm w/ interpolation to simulate MuTRiG functioning

Efficiency (old analysis)

SCSF-78MJ 3 layer ribbon efficiency for different cuts:

Eff [%] 1. threshold (0.5, 1.5, or 2.5 ph.) "working" 95 point 2. timing cut (no cut, $+3\sigma$, or $+5\sigma$ 90 no timing cut no timing cut 85 thr. 0.5 ph. thr. 1.5 ph. 3. cluster size (1 ch. or 2 ch.) no timing cut 1 ch. 1 ch. 80 thr. 0.5 ph. 0.5 phe. 1 ch. no cu 0.5 phe. 1 ch. 5o 0.5 phe. 1 ch. 3o 2 ch. 75 1.5 phe. 1 ch. no cu phe. 1 ch. 5a phe, 1 ch, 3o 0.5 phe, 2 ch, no cut 70 0.5 phe. 2 ch. 5a 0.5 phe. 2 ch. 3a 1.5 phe, 2 ch, no cut 1.5 phe, 2 ch, 5a 1.5 phe, 2 ch, 3o 65 2 6 8 12 timing cut 4 10 14 7153 Entries χ^2 / ndf 153.775 / 44

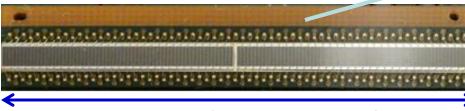


Si-PM Array

In hand

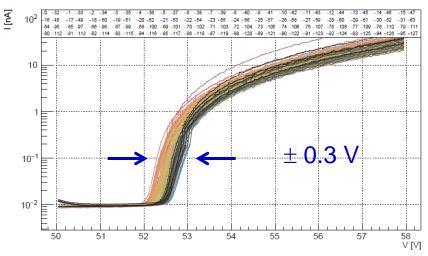
128 ch SiPM array from Hamamatsu (LHCb type) S13552HRQ

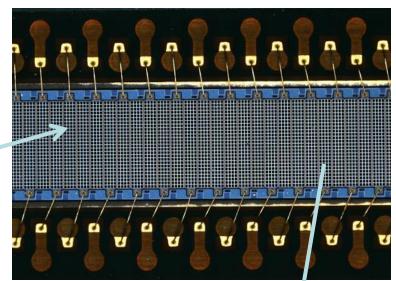
 $\begin{array}{l} 250 \ \mu\text{m pitch} \\ \text{pixel size 57.5 } \mu\text{m} \times 62.5 \ \mu\text{m} \\ 4 \times 16 \ \text{pixels per column} \\ 230 \ \mu\text{m} \times 1625 \ \mu\text{m column area} \\ V_{\text{break}} \ \text{\sim} 52.5 \ \text{V} \ (\pm 0.3 \ \text{V same array}) \\ \text{high quenching resistor} \end{array}$



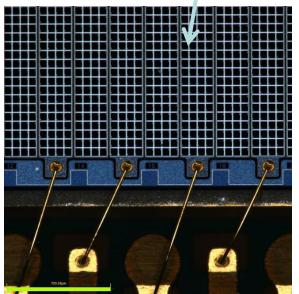
32.5 mm (two 64 ch. dies)

IV Curves: 04_S13552_49-60V





details



Front End Electronics

Readout of SiPM arrays using the MuTRiG chip (see Wei's talk)

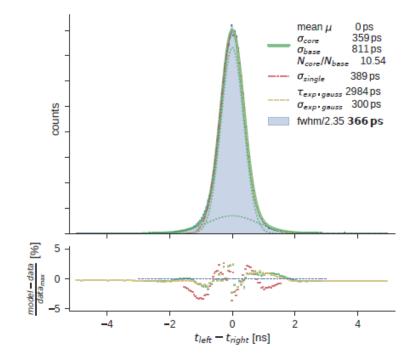
4 MuTRiG chips are required to read out one 128 channel SiPM array
1 FE board per Si-PM array (2 × 12 boards)

extremely tight space available for the FE chips directly bonded to the FE board

schematic representation of SciFi FE board (not to scale)

to DAQ SciFI FE board ~30 mm × ~40 mm

Under development



SciFi timing performance w/ MuTRiG reproduced timing resolution obtained in TB (4 layer SCSF-78MJ ribbon, 1 ch.)



SciFi Mechanics 1

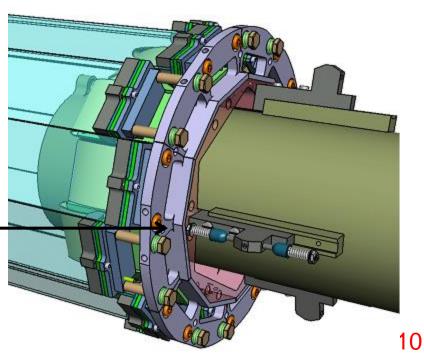
SciFi ribbons longitudinally staggered to minimize dead space between ribbons

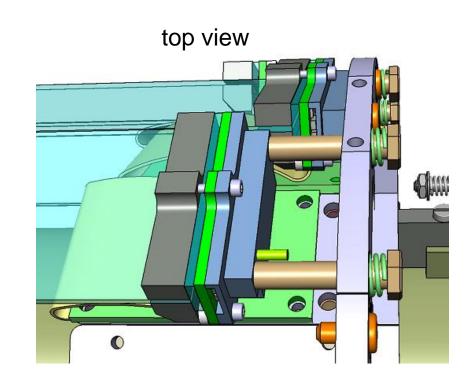
SiPM spring loaded support

fixations to beam pipe

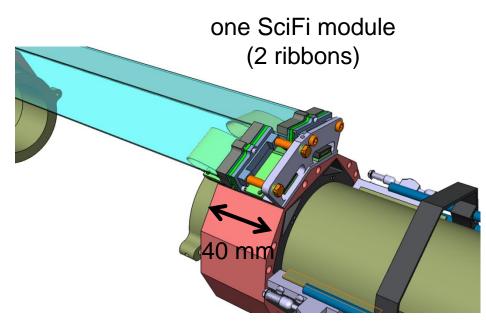
SciFi module support structure (2 ribbons per module)

cooling ring supports the SciFi modules

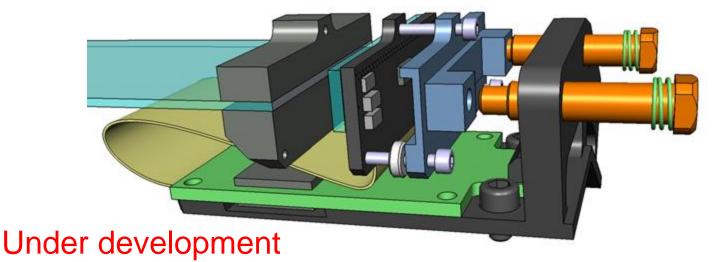




SciFi Mechanics 2



"expanded" view of SciFI – SiPM coupling + spring loaded SiPM support





SciFi ribbons

visual inspection of ribbons and of fiber polishing mechanical measurements of ribbons validation of each SciFi ribbon with beam or β source

SiPM arrays

I-V curves for each channel (+ DCR) visual inspection for surface defects

Front-End

validation of the SiPM – FE chain with e.g. a laser (excite the SiPM)

Ongoing Work

Finalize the mechanical design / integration

very tight space constraints connection to the Mu3e cooling system cooling of SiPM arrays thermal model "cabling"

Fully develop the SciFi Front End electronics extremely tight space constraints 4 MuTRiG chips per board develop FE board in steps

- 1. SciFi protoboard w/ 4 MuTRiG v1 chips almost ready validate SiPM array readout and DAQ integration
- 2. SciFi protoboard w/ 4 MuTRiG v2 chips once MuTRiG v2 is available
- 3. final design

Radiation hardness

SiPM arrays (studies ongoing, almost completed) Scintillating fibers MuTRiG

Outlook

BVR48	BVR49	BVR50
Q2/17	\checkmark	
Q2/17	\checkmark	
Q4/17	Q2/18	Q2/19
Q3/17	Q3/18	\checkmark
Q3/17	Q3/18	Q2/19
		Q2/19
		Q2/19
		Q4/19
Q3/17	Q3/18	Q3/19
	Q1/19	Q2/19
Q1/18	Q2/19	Q2/19
	Q4/19	Q4/19
	Q2/17 Q2/17 Q4/17 Q3/17 Q3/17	Q2/17 ✓ Q2/17 ✓ Q4/17 Q2/18 Q3/17 Q3/18 Q1/18 Q2/19





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